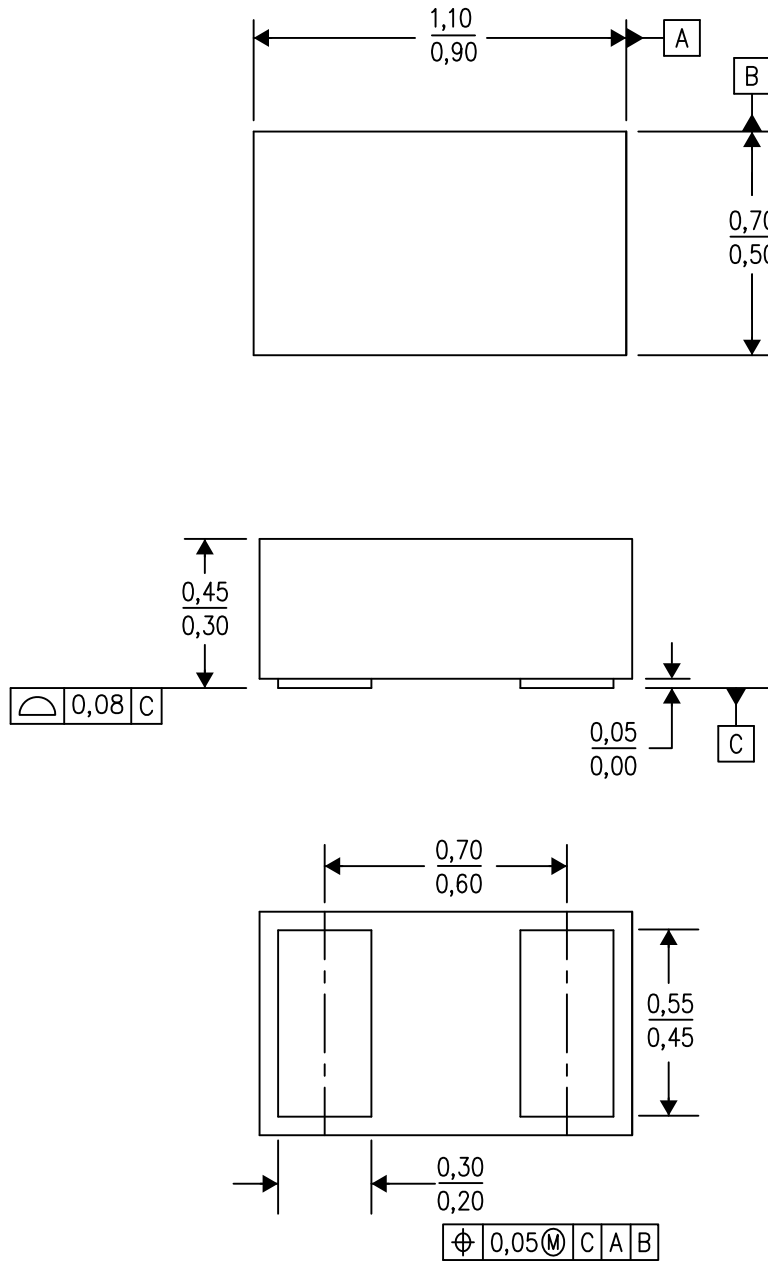


DPY (R-PX1SON-N2)

PLASTIC SMALL OUTLINE NO-LEAD



4211012/D 08/14

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5-1994.
 - This drawing is subject to change without notice.
 - SON (Small Outline No-Lead) package configuration.

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